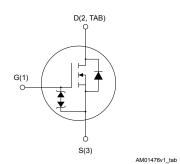
Datasheet

N-channel 600 V, 36 mΩ typ., 62 A, MDmesh DM6 Power MOSFETs in TO-247 and TO-247 long leads packages

Features







- Fast-recovery body diode
- Lower R_{DS(on)} per area vs previous generation
- · Low gate charge, input capacitance and resistance
- 100% avalanche tested
- · Extremely high dv/dt ruggedness
- Zener-protected

Applications

· Switching applications

Description

These high-voltage N-channel Power MOSFETs are part of the MDmesh DM6 fast-recovery diode series. Compared with the previous MDmesh fast generation, DM6 combines very low recovery charge (Q_{rr}), recovery time (t_{rr}) and excellent improvement in $R_{DS(on)}$ per area with one of the most effective switching behaviors available in the market for the most demanding high-efficiency bridge topologies and ZVS phase-shift converters.



Product status links

STW70N60DM6, STWA70N60DM6

Product summary				
STW70N60DM6				
Order code	STW70N60DM6			
Marking	70N60DM6			
Package	TO-247			
Packing	Tube			
STWA70	N60DM6			
Order code	STWA70N60DM6			
Marking	70N60DM6			
Package	TO-247 long leads			
Packing	Tube			



1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	±25	V
I _D	Drain current (continuous) at T _C = 25 °C	62	А
I _D	Drain current (continuous) at T _C = 100 °C	39	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	220	Α
P _{TOT}	Total power dissipation at T _C = 25 °C	390	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	100	V/ns
di/dt ⁽²⁾	Peak diode recovery current slope	1000	A/µs
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	100	V/ns
T _{stg}	Storage temperature range	55 to 150	°C
TJ	Operating junction temperature range	-55 to 150	°C

- 1. Pulse width is limited by safe operating area.
- 2. $I_{SD} \le 62\,A,\ V_{DS}\ (peak) < V_{(BR)DSS},\ V_{DD} = 400\ V.$
- 3. $V_{DS} \le 480 \text{ V}$.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance, junction-to-case	0.32	°C/W
R _{thJA}	Thermal resistance, junction-to-ambient	50	°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _J max)	7	Α
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	1850	mJ

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2 Electrical characteristics

 T_C = 25 °C unless otherwise specified

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0 V, I _D = 1 mA	600			V
		V _{GS} = 0 V, V _{DS} = 600 V			1	
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_J = 125 ^{\circ}\text{C}^{(1)}$			100	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±25 V			±5	μA
V _{GS(th)} Gate threshold voltage		$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.25	4	4.75	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 31 A		36	42	mΩ

^{1.} Specified by design, not tested in production.

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	4360	-	
C _{oss}	Output capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz, V}_{GS} = 0 \text{ V}$	-	235	-	nE
C _{rss}	Reverse transfer capacitance		-	13	-	pF
Coss eq. (1)	Equivalent output capacitance	V _{DS} = 0 to 480 V, V _{GS} = 0 V	-	697	-	
R _G	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	1.5	-	Ω
Q_g	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 62 \text{ A},$	-	99	-	
Q _{gs}	Gate-source charge	V _{GS} = 0 to 10 V (see Figure 14. Test circuit for gate	-	28	-	nC
Q _{gd}	Gate-drain charge	charge behavior)	-	44	-	

^{1.} $C_{\rm oss\ eq}$ is defined as a constant equivalent capacitance giving the same charging time as Coss when $V_{\rm DS}$ increases from 0 to 80% $V_{\rm DSS}$

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 31 A,	-	28	-	ns
t _r	Rise time	R_G = 4.7 Ω , V_{GS} = 10 V (see Figure 13. Test circuit for resistive load switching times and Figure 18. Switching time waveform)	-	49	-	ns
t _{d(off)}	Turn-off delay time		-	96	-	ns
t _f	Fall time		-	12	-	ns

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Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		62	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		220	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 62 A	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 62 A, di/dt = 100 A/μs,	-	138	-	ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V	-	0.69	-	μC
I _{RRM}	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	10	-	Α
t _{rr}	Reverse recovery time	I _{SD} = 62 A, di/dt = 100 A/μs,	-	340	-	ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V, T _J = 150 °C	-	4.6	-	μC
I _{RRM}	Reverse recovery current	(see Figure 15. Test circuit for inductive load switching and diode recovery times)	-	27	-	Α

^{1.} Pulse width is limited by safe operating area

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^{2.} Pulsed: pulse duration = 300 μs, duty cycle 1.5%



2.1 Electrical characteristics (curves)

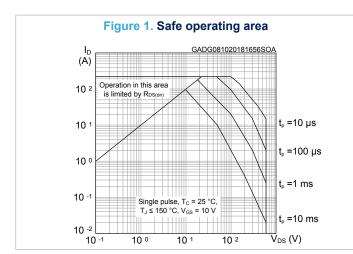
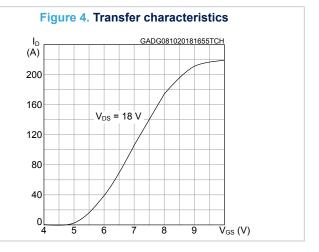


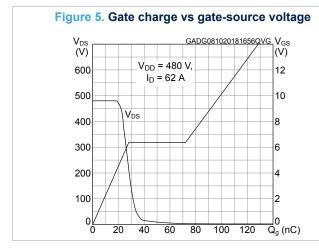
Figure 2. Thermal impedance

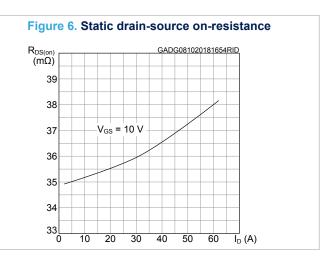
K

AM09125v1 0.02 0.05 0.02 0.02 0.01 0.02 0.02 0.02 0.02 0.03 0.04 0.05 0

Figure 3. Output characteristics Ι_D (A) GADG081020181655OCH V_{GS} = 9, 10 V 200 $V_{GS} = 8 V$ 160 $V_{GS} = 7 V$ 120 80 V_{GS} = 6 V 40 $V_{GS} = 5 V$ 16 12 $\vec{\overline{V}}_{DS}(V)$







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Figure 7. Capacitance variations

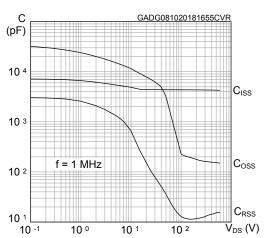


Figure 8. Coss stored energy vs VDS

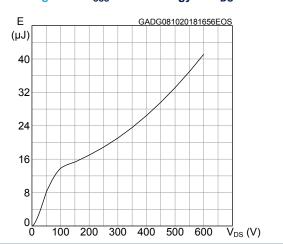


Figure 9. Normalized gate threshold voltage vs temperature

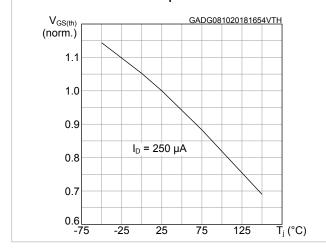


Figure 10. Normalized on-resistance vs temperature

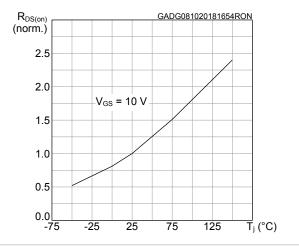


Figure 11. Normalized V_{(BR)DSS} vs temperature

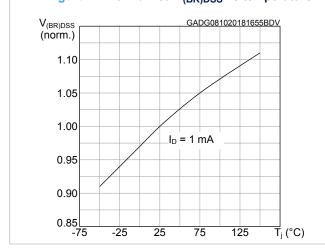
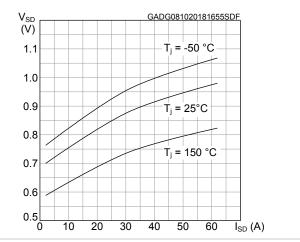


Figure 12. Source-drain diode forward characteristics



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3 Test circuits

Figure 13. Test circuit for resistive load switching times

 V_{GS} V_{G

Figure 14. Test circuit for gate charge behavior

Figure 15. Test circuit for inductive load switching and diode recovery times

AM01468v1

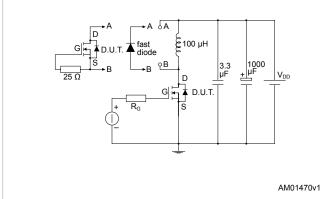


Figure 16. Unclamped inductive load test circuit

Figure 17. Unclamped inductive waveform

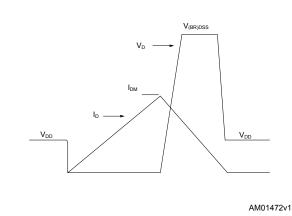
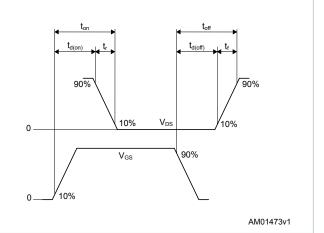


Figure 18. Switching time waveform



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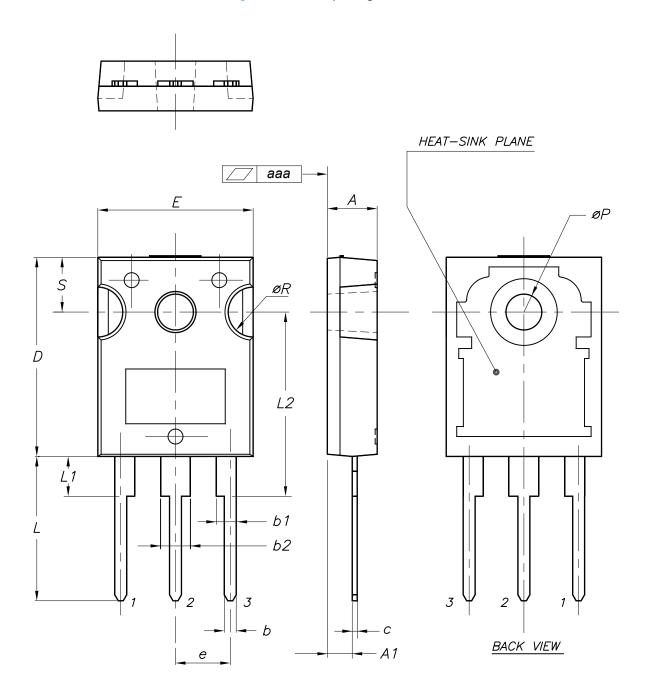


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 TO-247 package information

Figure 19. TO-247 package outline



0075325_10

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Table 8. TO-247 package mechanical data

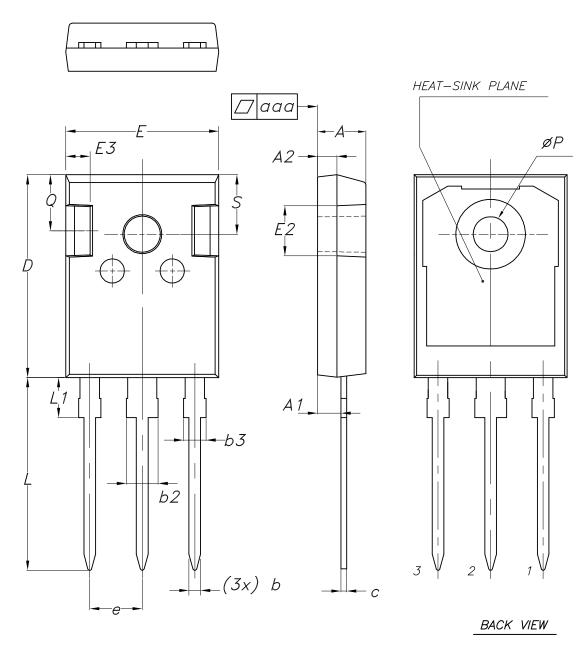
Dim.	mm				
Dilli.	Min.	Тур.	Max.		
Α	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		
aaa		0.04	0.10		

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4.2 TO-247 long leads package information

Figure 20. TO-247 long leads package outline



8463846_3

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Table 9. TO-247 long leads package mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.26
b2			3.25
b3			2.25
С	0.59		0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
е	5.34	5.44	5.54
L	19.80	19.92	20.10
L1			4.30
Р	3.50	3.60	3.70
Q	5.60		6.00
S	6.05	6.15	6.25
aaa		0.04	0.10

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Revision history

Table 10. Document revision history

Date	Revision	Changes
02-Nov-2017	1	First release.
		Removed maturity status indication from cover page. The document status is production data.
10-Oct-2018	2	Updated Section 1 Electrical ratings and Section 2 Electrical characteristics.
		Added Section 2.1 Electrical characteristics (curves).
		Minor text changes.
02 May 2010	2	Updated Table 6. Switching times.
02-May-2019	3	Minor text changes.
01-Jun-2020	4	Updated Table 1. Absolute maximum ratings and Table 7. Source drain diode.
		Updated Table 4. On/off states.
04 Feb 2002	F	Updated Coss eq. on Table 5. Dynamic characteristics.
21-Feb-2023	5	Updated Section 4 Package information.
		Minor text changes.

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